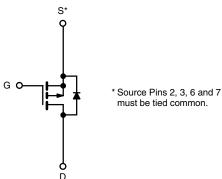


IRF7704TRPBF-VB Datasheet Dual P-Channel 30-V (D-S) MOSFET

| PRODU | ICT SUMMARY | | |
|---------------------|-----------------------------------|------------------------------------|-----------------------|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) ^{d, e} | Q _g (Typ.) |
| - 30 | 0.016 at V _{GS} = - 10 V | - 9.5 | 15 nC |
| - 30 | 0.020 at V_{GS} = - 4.5 V | - 8.0 | 13110 |



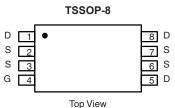
P-Channel MOSFET

FEATURES

- · Halogen-free
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

- Load Switches
 - Notebook PCs
 - Desktop PCs
 - Game Stations



RoHS COMPLIANT

| Parameter | Symbol | Limit | Unit | |
|--|------------------------|-----------------------------------|-----------------------|-----|
| Drain-Source Voltage | | V _{DS} | - 30 | V |
| Gate-Source Voltage | V _{GS} | ± 20 | | |
| | T _C = 25 °C | | - 9.5 ^e | |
| Continuous Drain Current (T ₁ = 150 °C) | T _C = 70 °C | | - 8.0 ^e | |
| Continuous Drain Current (1) = 150°C) | T _A = 25 °C | I _D | - 8.3 ^{a, b} | |
| | T _A = 70 °C | | - 7.9 ^{a, b} | ٨ |
| Pulsed Drain Current | | I _{DM} | - 32 ^e | — A |
| Continuous Source-Drain Diode Current | T _C = 25 °C | 1- | - 4.1 | |
| Commuous Source-Drain Diode Current | T _A = 25 °C | Is Is | - 2.0 ^{a, b} | |
| Avalanche Current | L = 0.1 mH | I _{AS} | - 20 | |
| Single-Pulse Avalanche Energy | | E _{AS} | 20 | mJ |
| | T _C = 25 °C | | 5.0 | |
| Maximum Bawar Disgination | T _C = 70 °C | P _D | 3.2 | w |
| Maximum Power Dissipation | T _A = 25 °C | 'D | 2.5 ^{a, b} | vv |
| | T _A = 70 °C | | 1.6 ^{a, b} | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stq} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 38 | 50 | °C/W |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 20 | 25 | C/W |

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 °C/W.

d. Based on T_C = 25 °C.

e. Limited by package.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|---|-------|----------|------------|-----------|
| Static | - | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = - 250 μA | - 30 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | | | - 31 | | 24/20 |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μA | | 4.5 | | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1.0 | | - 3.0 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$ | | | - 1 - 5 | μA |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge$ - 10 V, V_{GS} = - 10 V | - 30 | | | A |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -10 \text{ V}, \text{ I}_{D} = -7.3 \text{ A}$ $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -6.2 \text{ A}$ | | 0.016 | | Ω |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 9.1 A | | 23 | | S |
| Dynamic ^b | | | | 1 | | |
| Input Capacitance | C _{iss} | | | 1350 | | |
| Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 215 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 185 | | |
| Total Gate Charge | Qg | V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 9.1 A | | 32 15 | 50 25 | |
| Gate-Source Charge | Q _{gs} | V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 9.1 A | | 4 | 20 | nC |
| Gate-Drain Charge | Q _{gd} | | | 7.5 | | |
| Gate Resistance | R _g | f = 1 MHz | | 5.8 | | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | |
| Rise Time | t _r | V_{DD} = - 15 V, R _L = 15 Ω | | 8 | 15 | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 45 | 70 | |
| Fall Time | t _f | Ŭ | | 12 | 25 | |
| Turn-On Delay Time | t _{d(on)} | | | 42 | 70 | - ns - |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 15 Ω | | 35 | 60 | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 40 | 70 | |
| Fall Time | t _f | | | 16 | 30 | |
| Drain-Source Body Diode Characterist | ics | | | • | • | |
| Continous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | - 4.1 | ٨ |
| Pulse Diode Forward Current | I _{SM} | | | | - 32 | A |
| Body Diode Voltage | V _{SD} | I _S = - 2 A, V _{GS} = 0 V | | - 0.75 | - 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 34 | 60 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | L = 2.0 dt/dt = 100.0 / up T = 25.00 | | 22 | 40 | nC |
| Reverse Recovery Fall Time | t _a | - I _F = - 2 A, dl/dt = 100 A/μs, T _J = 25 °C | | 11 | | 20 |
| Reverse Recovery Rise Time | t _b | | | 23 | | ns |

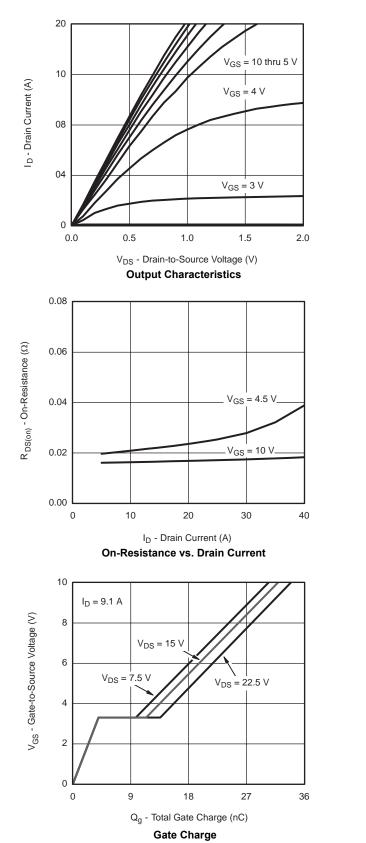
Notes:

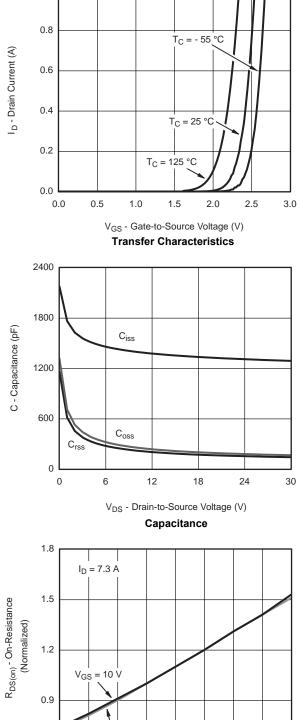
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.







V_{GS} = 4.5 V

25

50

T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

75

100

125 150

0

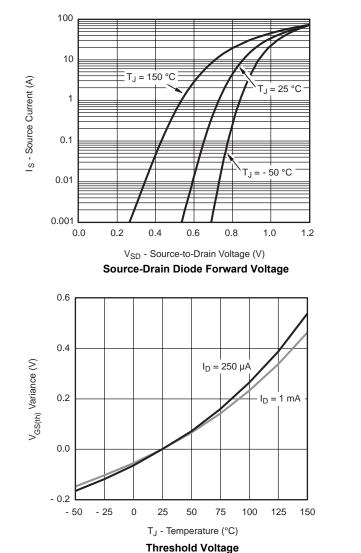
0.6

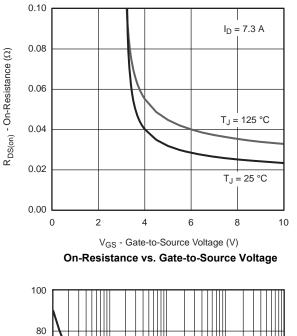
- 50

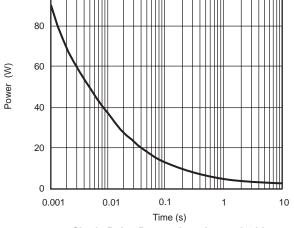
- 25

1.0

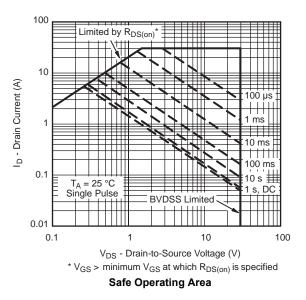




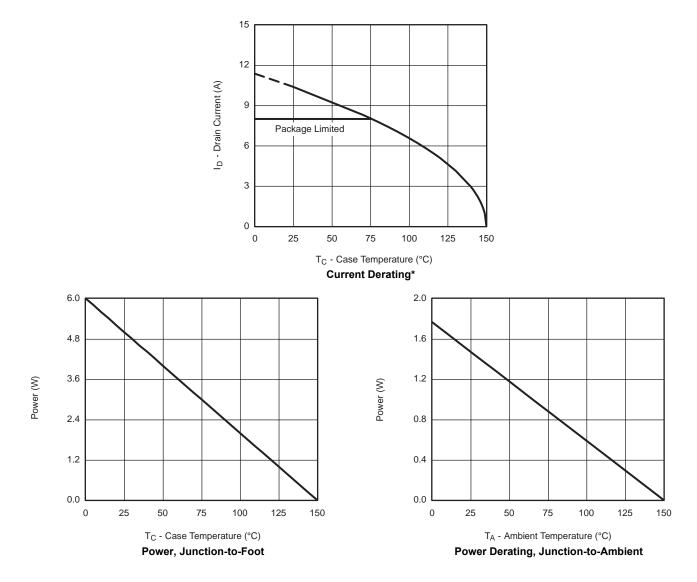




Single Pulse Power, Junction-to-Ambient

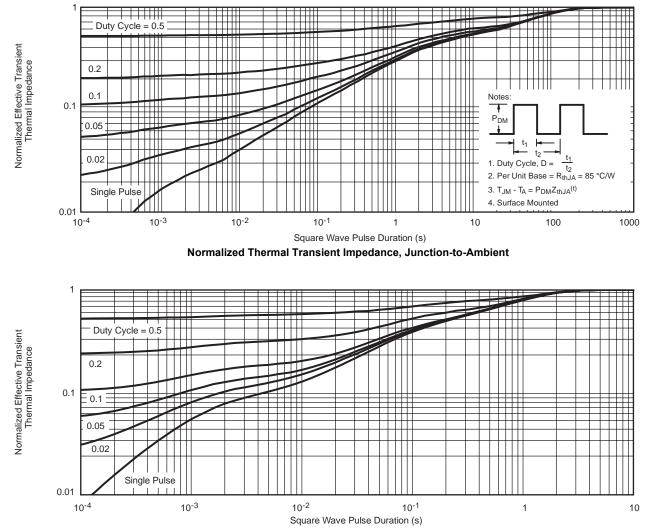






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





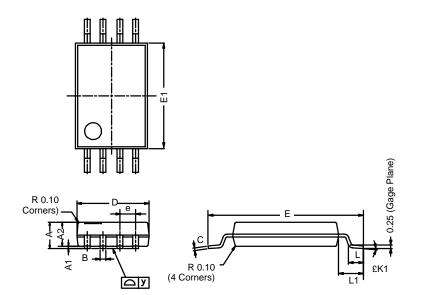
Normalized Thermal Transient Impedance, Junction-to-Foot

IRF7704TRPBF-VB



TSSOP: 8-LEAD

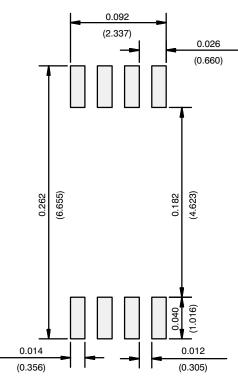
JEDEC Part Number: MO-153



| Dim | MILLIMETERS | | | | |
|----------------|-------------|-------|------|--|--|
| | Min | Nom | Max | | |
| Α | - | - | 1.20 | | |
| A 1 | 0.05 | 0.10 | 0.15 | | |
| A ₂ | 0.80 | 1.00 | 1.05 | | |
| В | 0.19 | 0.28 | 0.30 | | |
| С | - | 0.127 | - | | |
| D | 2.90 | 3.00 | 3.10 | | |
| Е | 6.20 | 6.40 | 6.60 | | |
| E ₁ | 4.30 | 4.40 | 4.50 | | |
| е | - | 0.65 | - | | |
| L | 0.45 | 0.60 | 0.75 | | |
| L ₁ | 0.90 | 1.00 | 1.10 | | |
| Y | - | - | 0.10 | | |
| £ K1 | 0° | 3° | 6° | | |



RECOMMENDED MINIMUM PADS FOR TSSOP-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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